

November 2013

FFPF20UP30DN 20 A, 300 V, Ultrafast Dual Diode

Features

- Ultrafast Recovery t_{rr} = 45 ns (@ I_F = 10 A)
- Max Forward Voltage, $V_F = 1.3 \text{ V } (@ T_C = 25^{\circ}\text{C})$
- Reverse Voltage, V_{RRM} = 300 V
- · Avalanche Energy Rated
- RoHS Compliant

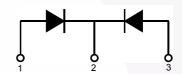
Applications

- . General Purpose
- · SMPS, Power Switching Circuits
- · Free-Wheeling Diode for Motor Application

Description

The FFPF20UP30DN is an ultrafast dual diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applicationa as welder and UPS application.





1. Anode 2. Cathode 3. Anode

Absolute Maximum Ratings (per diode) Ta = 25°C unless otherwise noted

Symbol	Parameter	Rating	Unit
V _{RRM}	Peak Repetitive Reverse Voltage	300	V
V _{RWM}	Working Peak Reverse Voltage	300	V
V _R	DC Blocking Voltage	300	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 125°C	10	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	100	Α
T _J , T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

Thermal Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	4.0	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFPF20UP30DNTU	FFPF20UP30DN	TO-220F	Tube	N/A	N/A	30

Electrical Characteristics (per diode) T_a = 25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Unit
V _F *	I _F = 10 A I _F = 10 A	T _C = 25 °C T _C = 150 °C	-	-	1.3 1.2	V V
I _{R *}	V _R = 300 V V _R = 300 V	T _C = 25 °C T _C = 150 °C	-	-	100 500	μ Α μ Α
t _{rr}	$I_F = 1 \text{ A, di}_F/\text{dt} = 100 \text{ A/}\mu\text{s, V}_R = 30 \text{ V I}_F$ = 10 A, di $_F/\text{dt} = 200 \text{ A/}\mu\text{s, V}_R = 195 \text{ V}$	T _C = 25 °C T _C = 25 °C	-	-	35 45	ns ns
t _a t _b Q _{rr}	I_F =10 A, di _F /dt = 200 A/ μ s, V _R = 195 V T_C = 25 T_C = 25 T_C = 25		- - -	11 13 20	- - -	ns ns nC
W _{AVL}	Avalanche Energy (L = 20 mH)		20	-	-	mJ

^{*}Pulse Test: Pulse Width=300 μ s, Duty Cycle=2%

Test Circuit and Waveforms

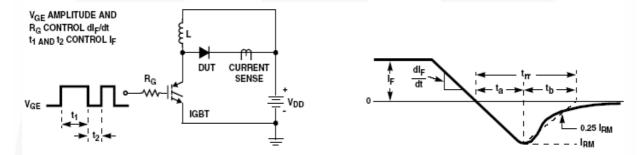


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

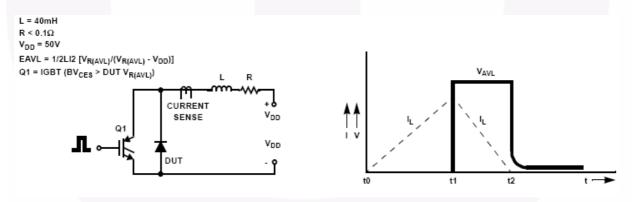


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

Typical Performance Characteristics

Figure 3. Typical Forward Voltage Drop

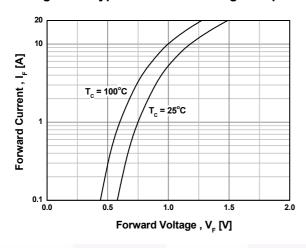


Figure 4. Typical Reverse Current

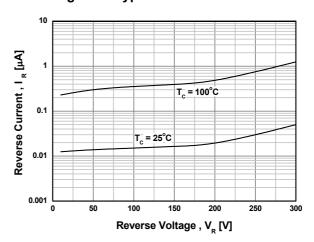


Figure 5. Typical Junction Capacitance

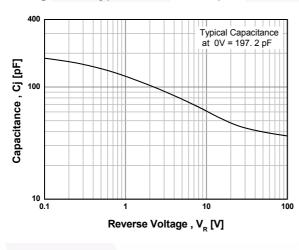


Figure 6. Typical Reverse Recovery Time

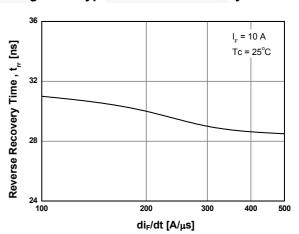


Figure 7. Typical Reverse Recovery Current

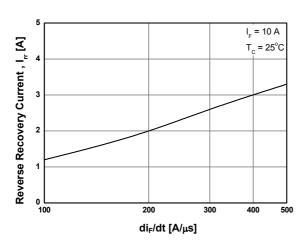
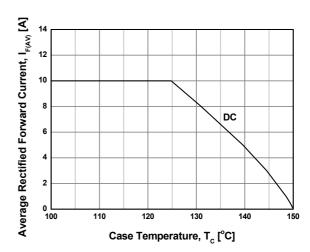


Figure 8. Forward Current Deration Curve



Package Dimensions

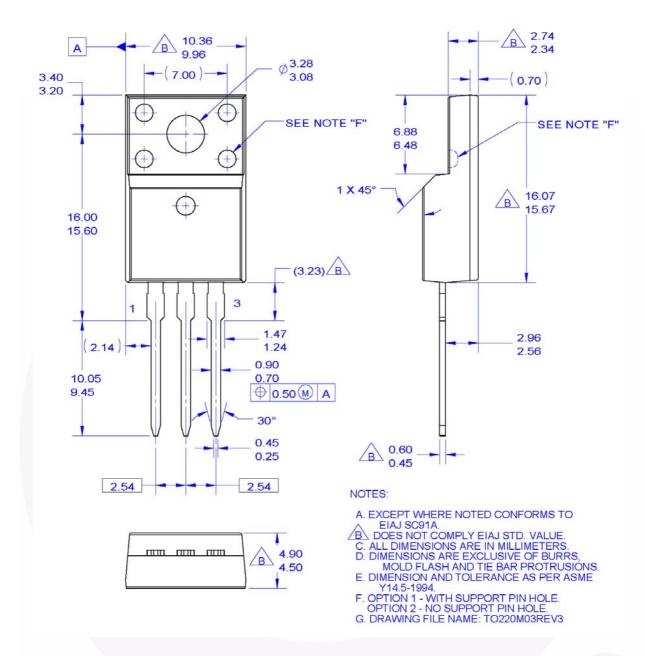


Figure 9. TO-220F 3L - TO220, MOLDED, 3LD, FULL PACK, EIAJ SC91, STRAIGHT LEAD

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